

International IR Rectifier

SERIES IRK.136, .142, .162

**THYRISTOR/DIODE and
THYRISTOR/THYRISTOR**

NEW INT-A-pak Power Modules

Features

- High Voltage
- Electrically Isolated by DBC Ceramic (Al_2O_3)
- 3500 V_{RMS} Isolating Voltage
- Industrial Standard Package
- High Surge Capability
- Glass Passivated Chips
- Modules uses High Voltage Power thyristor/diodes in three Basic Configurations
- Simple Mounting
- UL E78996 approved 

135 A
140 A
160 A

Applications

- DC Motor Control and Drives
- Battery Charges
- Welders
- Power Converters
- Lighting Control
- Heat and Temperature Control

Major Ratings and Characteristics

Parameters	IRK.136..	IRK.142..	IRK.162..	Units
$I_{T(AV)}$	135	140	160	A
@ T_C	85	85	85	°C
$I_{T(RMS)}$	300	310	355	A
I_{TSM} @ 50Hz	3200	4500	4870	A
@ 60Hz	3360	4712	5100	A
I^2t @ 50Hz	51.5	102	119	KA ² s
@ 60Hz	47	92.5	108	KA ² s
$I^2\sqrt{t}$	515.5	1013	1190	KA ² √s
V_{RRM}	400 to 1600			V
T_J range	-40 to 125			°C

CASE STYLE NEW INT-A-PAK



Electrical Specifications

Voltage Ratings

Type number	Voltage Code	V_{RRM}/V_{DRM} , Maximum repetitive peak reverse voltage V	V_{RSM}/V_{DSM} , Maximum non-repetitive peak reverse voltage V	I_{RRM}/I_{DRM} @ 125°C mA
IRK.136	04	400	500	50
IRK.142	08	800	900	
IRK.162	12	1200	1300	
	14	1400	1500	
	16	1600	1700	

Forward Conduction

Parameter	IRK.136	IRK.142	IRK.162	Units	Conditions
$I_{T(AV)}$ Max. average on-state current @ Case temperature	135	140	160	A	180° conduction, half sine wave
	85	85	85	°C	
$I_{T(RMS)}$ Max. RMS on-state current	300	310	355	A	as AC switch
I_{TSM} Maximum peak, one-cycle on-state, non-repetitive surge current	3200	4500	4870	A	t = 10ms No voltage
	3360	4712	5100		t = 8.3ms reapplied
	2700	3785	4100		t = 10ms 100% V_{RRM}
	2800	3963	4300		t = 8.3ms reapplied
I^2t Maximum I^2t for fusing	51.5	102	119	KA ² s	t = 10ms No voltage
	47	92.5	108		t = 8.3ms reapplied
	36.5	71.6	84		t = 10ms 100% V_{RRM}
	33.3	65.4	76.7		t = 8.3ms reapplied
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	515.5	1013	1190	KA ² /s	t = 0.1 to 10ms, no voltage reapplied
$V_{T(TO)1}$ Low level value of threshold voltage	0.86	0.83	0.8	V	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, @ T_J max.
$V_{T(TO)2}$ High level value of threshold voltage	1.05	1	0.98	V	$(I > \pi \times I_{T(AV)})$, @ T_J max.
r_{T1} Low level value on-state slope resistance	2.02	1.78	1.67	mΩ	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, @ T_J max.
r_{T2} High level value on-state slope resistance	1.65	1.43	1.38	mΩ	$(I > \pi \times I_{T(AV)})$, @ T_J max.
V_{TM} Maximum forward voltage drop	1.57	1.55	1.54	V	$I_{TM} = \pi \times I_{T(AV)}$, $T_J = 25^\circ\text{C}$, 180° conduction
I_H Maximum holding current	200			mA	Anode supply = 6V initial $I_T = 30A$, $T_J = 25^\circ\text{C}$
I_L Maximum latching current	400			mA	Anode supply = 6V resistive load = 1Ω Gate pulse: 10V, 100μs, $T_J = 25^\circ\text{C}$

Switching

t_{gd} Typical delay time	1	μs	$T_J = 25^\circ\text{C}$	Gate Current=1A $di/dt=1A/\mu s$
t_{gr} Typical rise time	2		$T_J = 25^\circ\text{C}$	$V_d=0.67\% V_{DRM}$
t_q Typical turn-off time	50 - 200		$I_{TM} = 300A$; $-di/dt = 15A/\mu s$; $T_J = T_J$ max $V_T = 50V$; $dV/dt = 20V/\mu s$; Gate 0V, 100Ω	

Blocking

I_{RRM}	Maximum peak reverse and off-state leakage current	50	mA	$T_J = 125^\circ\text{C}$
V_{INS}	RMS isolation voltage	3500	V	50Hz, circuit to base, all terminals shorted, $t = 1\text{s}$
dV/dt	critical rate of rise of off-state voltage	1000	V/ μs	$T_J = T_{J\text{max.}}$, exponential to 67% rated V_{DRM}

Triggering

Parameter	IRK.136	IRK.142	IRK.162	Units	Conditions
P_{GM}	12			W	$t_p \leq 5\text{ms}$, $T_J = T_{J\text{max.}}$
$P_{G(AV)}$	3			W	$f = 50\text{Hz}$, $T_J = T_{J\text{max.}}$
I_{GM}	3			A	$t_p \leq 5\text{ms}$, $T_J = T_{J\text{max.}}$
$-V_{GT}$	10			V	
V_{GT}	Max. required DC gate voltage to trigger	4		V	$T_J = -40^\circ\text{C}$
		2.5			$T_J = 25^\circ\text{C}$
		1.7			$T_J = T_{J\text{max.}}$
I_{GT}	Max. required DC gate current to trigger	270		mA	$T_J = -40^\circ\text{C}$
		150			$T_J = 25^\circ\text{C}$
		80			$T_J = T_{J\text{max.}}$
V_{GD}	0.3			V	@ $T_J = T_{J\text{max.}}$, rated V_{DRM} applied
I_{GD}	10			mA	
di/dt	300			A/ μs	@ $T_J = T_{J\text{max.}}$, $I_{TM} = 400\text{A}$ rated V_{DRM} applied

Thermal and Mechanical Specifications

Parameter	IRK.136	IRK.142	IRK.162	Units	Conditions
T_J	-40 to 125			$^\circ\text{C}$	
T_{stg}	-40 to 150			$^\circ\text{C}$	
R_{thJC}	0.18	0.18	0.16	K/W	DC operation, per junction
R_{thCS}	0.05			K/W	Mounting surface smooth, flat and greased Per module
T	Mounting IAP to heatsink	4 to 6		Nm	A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Lubricated threads.
	torque $\pm 10\%$ busbar to IAP	4 to 6			
wt	200 (7.1)			g(oz)	
Case Style	New Int-A-Pak				

ΔR Conduction (per Junction)

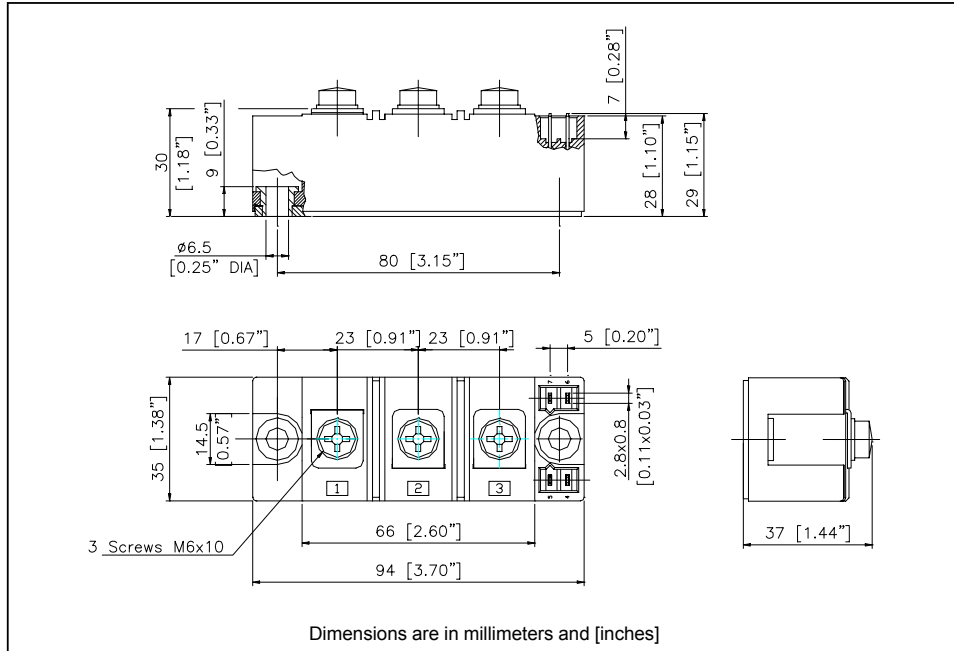
(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Devices	Sinusoidal conduction @ T_J max.					Rectangular conduction @ T_J max.					Units
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
IRK.136	0.007	0.01	0.013	0.0155	0.017	0.009	0.012	0.014	0.015	0.017	K/W
IRK.142	0.0019	0.0019	0.0020	0.0020	0.0021	0.0018	0.0022	0.0023	0.0023	0.0020	
IRK.162	0.0030	0.0031	0.0032	0.0033	0.0034	0.0029	0.0036	0.0039	0.0041	0.0040	

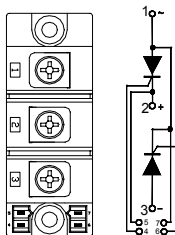
Ordering Information Table

Device Code				
1	2	3	4	
IRK	T	162	/	16
1	- Module Type			
2	- Circuit Configuration			
3	- Current Rating: $I_{T(AV)}$			
4	- Voltage Code: Code x 100 = V_{RRM}			

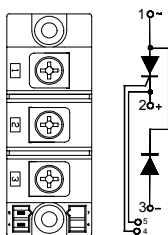
Outline Table



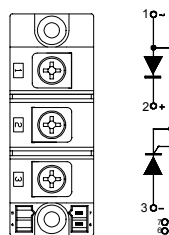
IRKT



IRKH



IRKL



NOTE: To order the Optional Hardware see Bulletin I27900

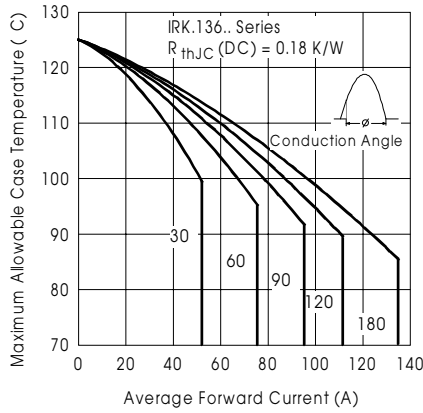


Fig. 1 - Current Ratings Characteristics

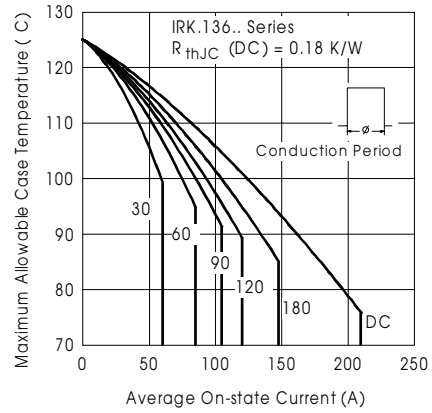


Fig. 2 - Current Ratings Characteristics

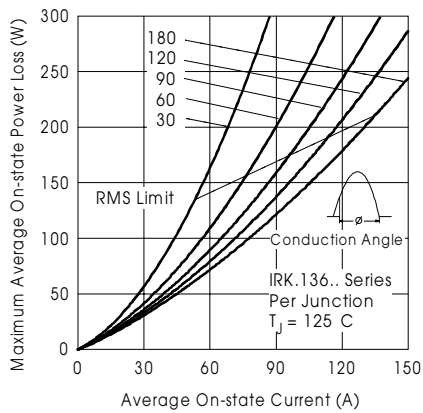


Fig. 3 - On-State Power Loss Characteristics

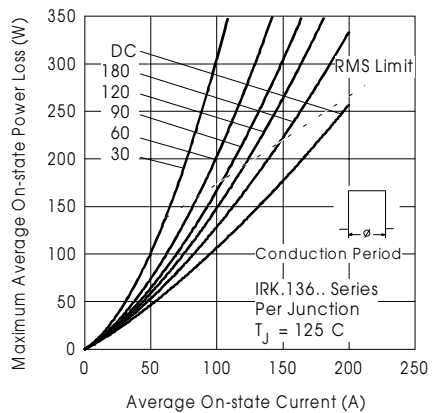


Fig. 4 - On-State Power Loss Characteristics

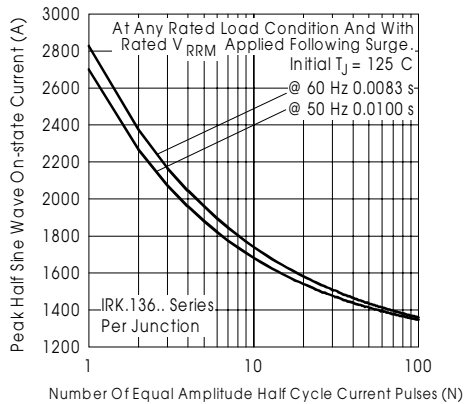


Fig. 5 - Maximum Non-Repetitive Surge Current

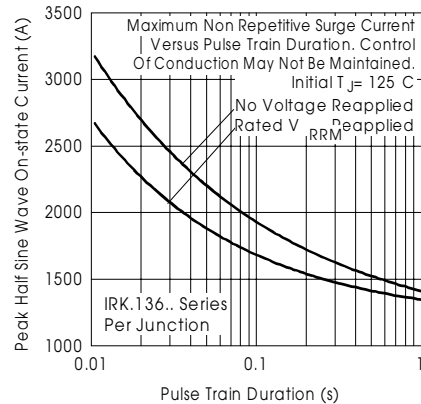


Fig. 6 - Maximum Non-Repetitive Surge Current

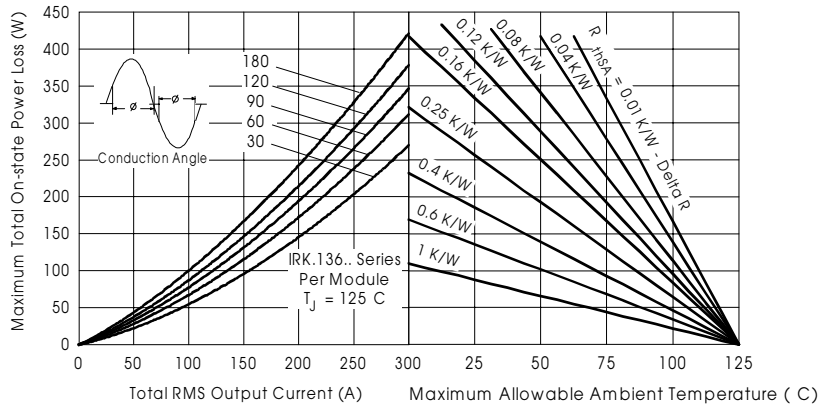


Fig.7 - On State Power Loss Characteristics

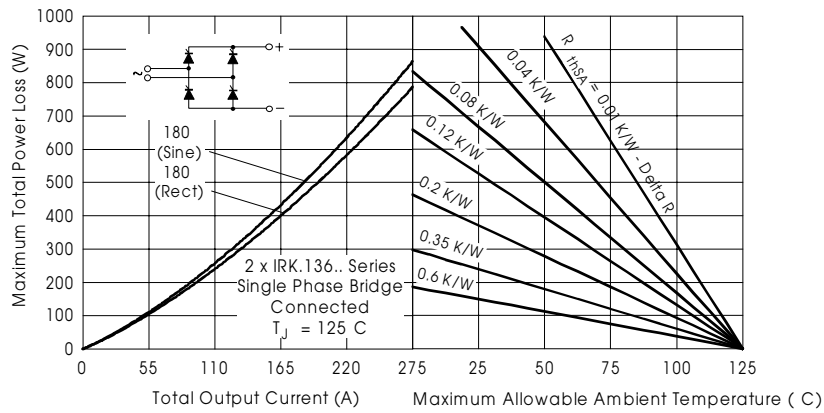


Fig.8 - On State Power Loss Characteristics

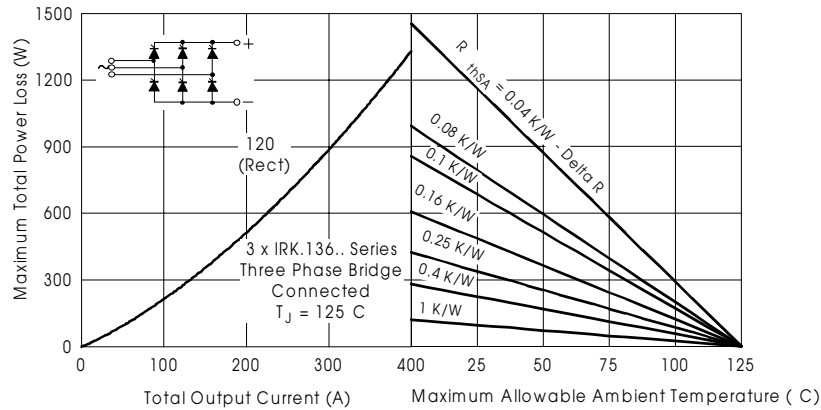


Fig.9 - On State Power Loss Characteristics

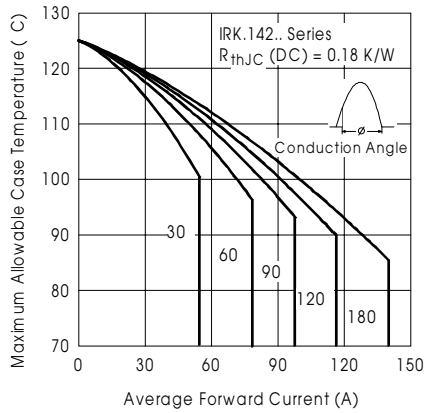


Fig. 10 - Current Ratings Characteristics

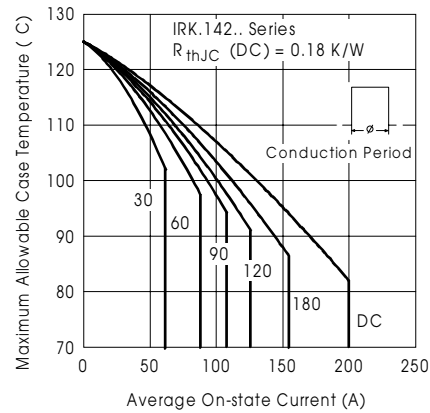


Fig. 11 - Current Ratings Characteristics

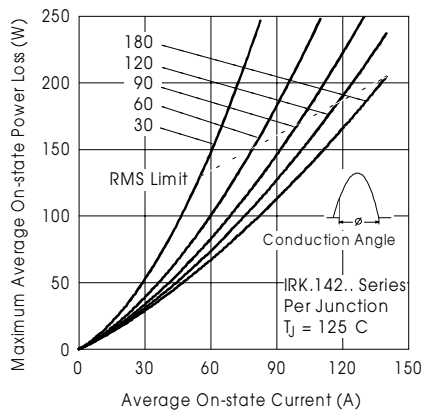


Fig. 12 - On-State Power Loss Characteristics

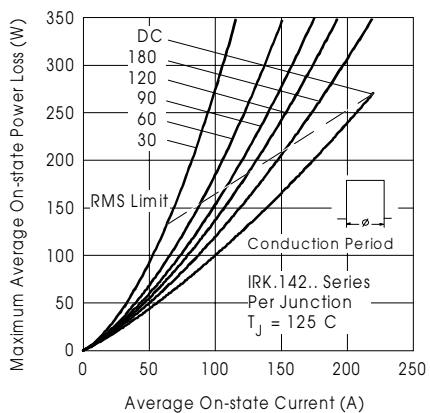


Fig. 13 - On-State Power Loss Characteristics

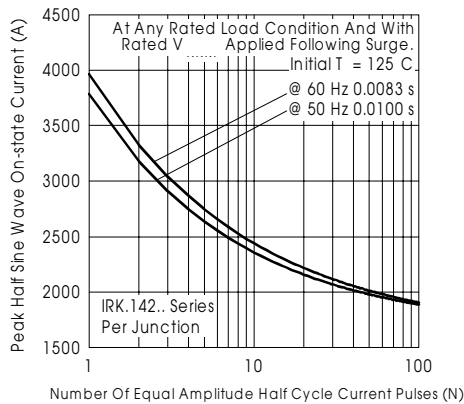


Fig. 14 - Maximum Non-Repetitive Surge Current

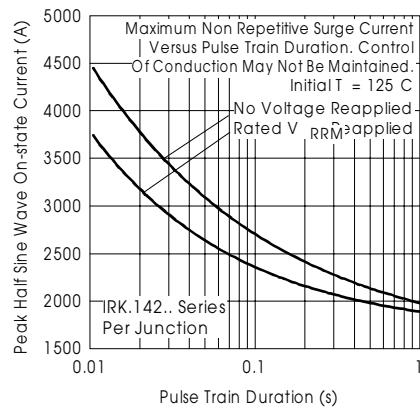


Fig. 15 - Maximum Non-Repetitive Surge Current

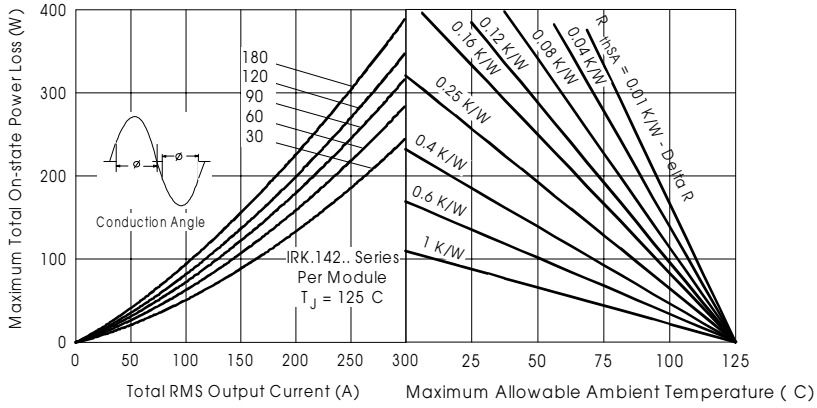


Fig.16 - On State Power Loss Characteristics

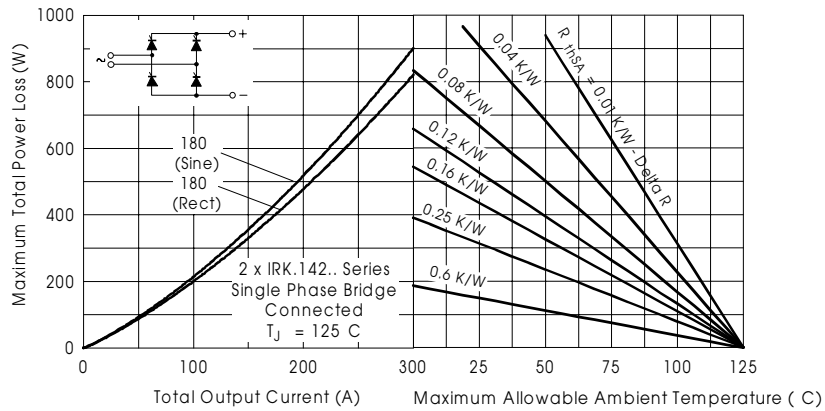


Fig.17 - On State Power Loss Characteristics

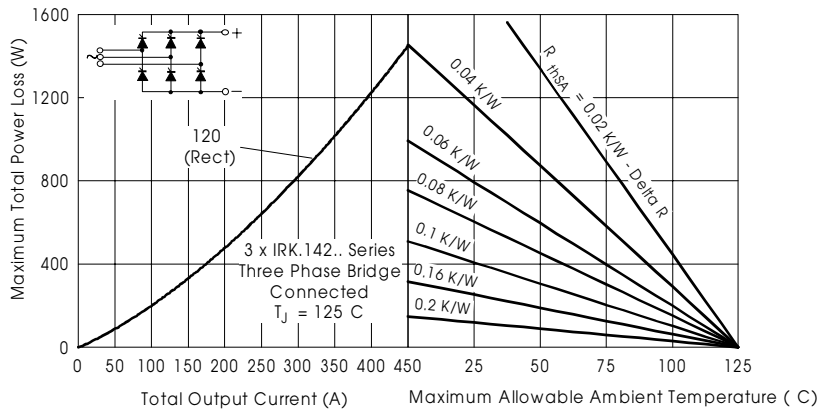


Fig.18 - On State Power Loss Characteristics

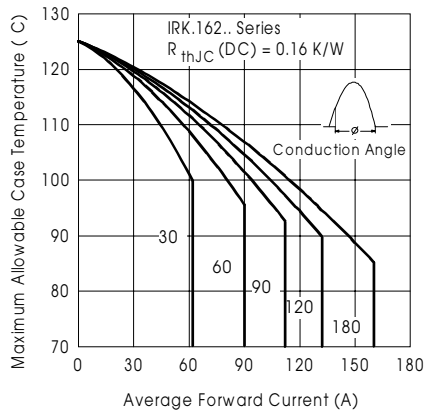


Fig. 19 - Current Ratings Characteristics

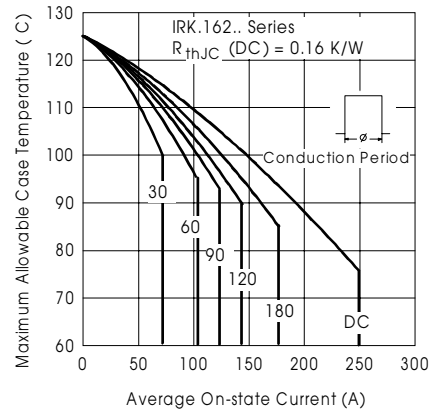


Fig. 20 - Current Ratings Characteristics

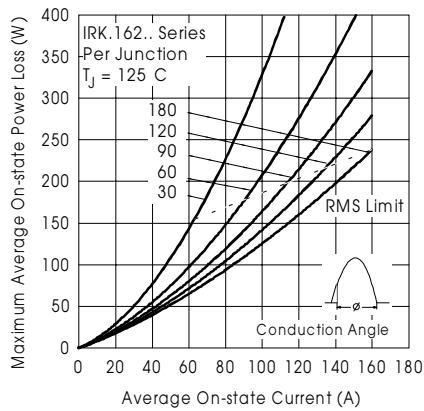


Fig. 21 - On-State Power Loss Characteristics

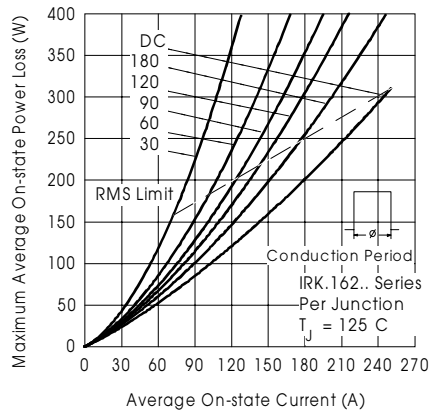


Fig. 22 - On-State Power Loss Characteristics

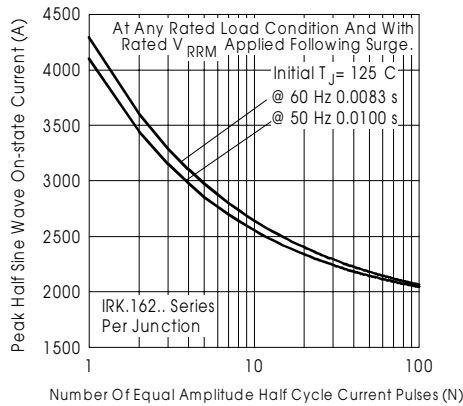


Fig. 23 - Maximum Non-Repetitive Surge Current

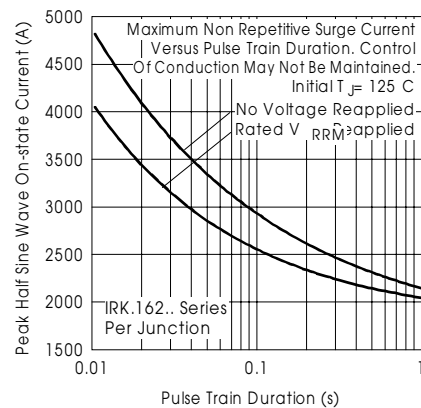


Fig. 24 - Maximum Non-Repetitive Surge Current

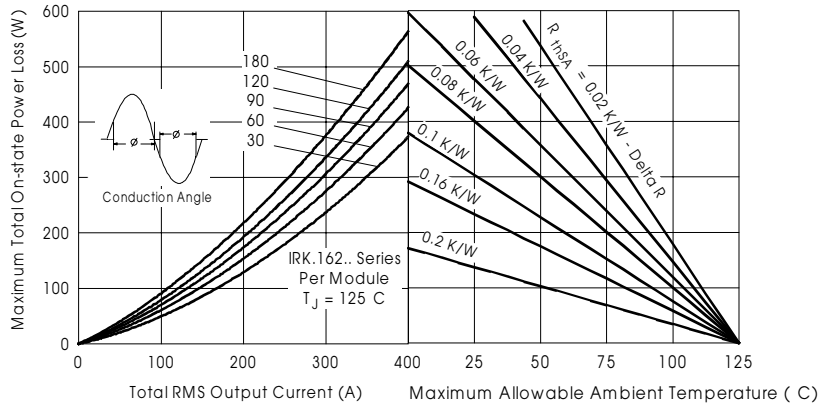


Fig.25- On State Power Loss Characteristics

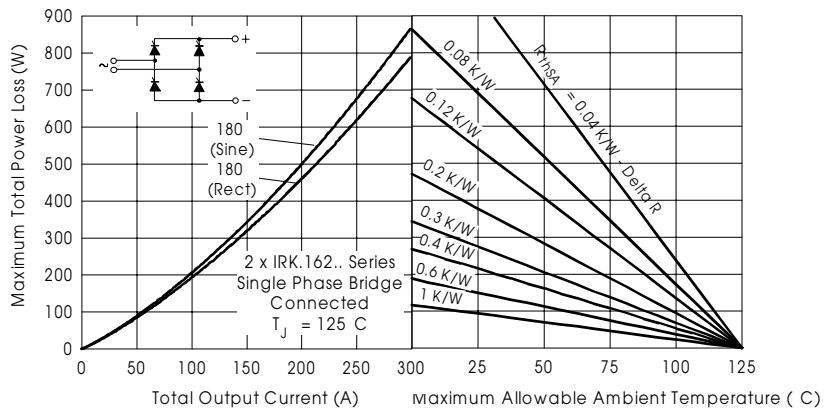


Fig.26- On State Power Loss Characteristics

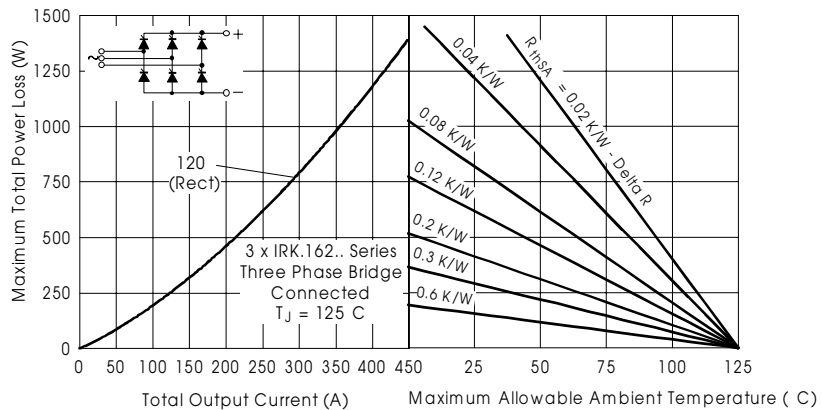


Fig.27- On State Power Loss Characteristics

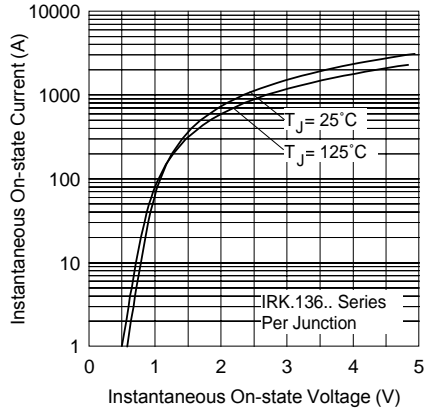


Fig.28 - On State Voltage Drop Characteristics

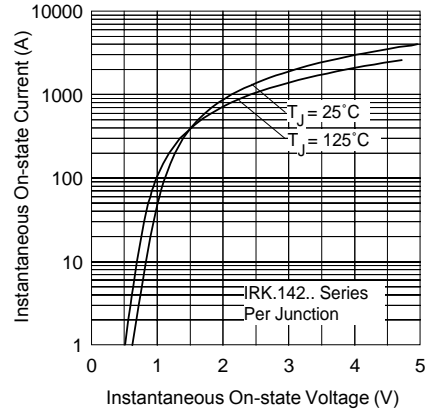


Fig.29 - On State Voltage Drop Characteristics

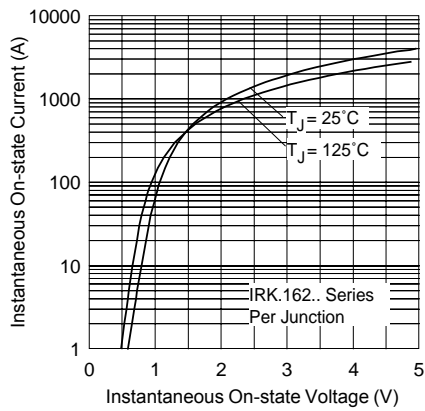


Fig.30 - On State Voltage Drop Characteristics

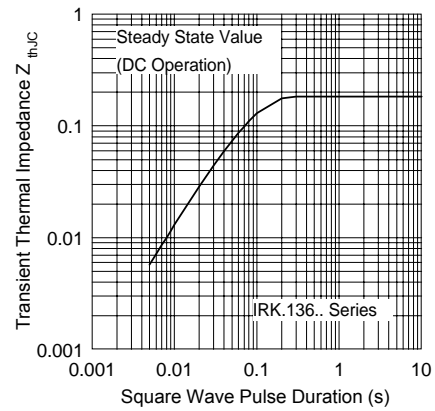


Fig.31 - Thermal Impedance ZthJC Characteristics

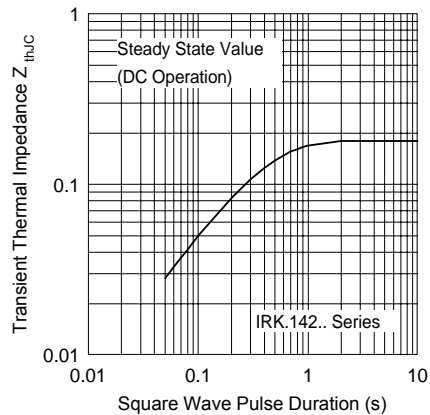


Fig.32 - Thermal Impedance ZthJC Characteristics

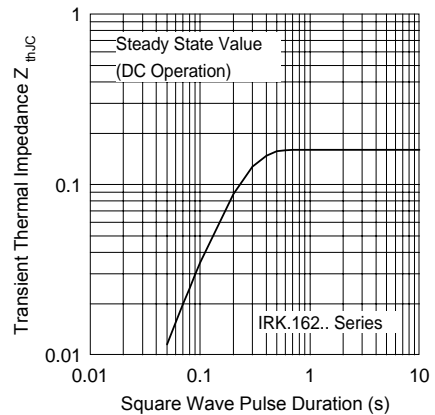


Fig.33 - Thermal Impedance ZthJC Characteristics

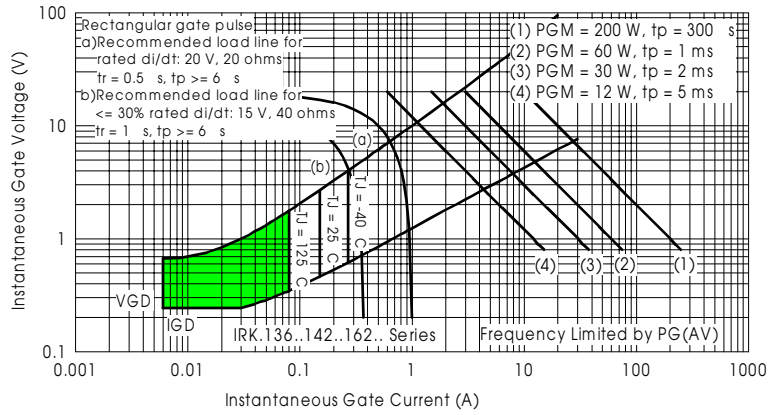


Fig. 34 - Gate Characteristics

Data and specifications subject to change without notice.
 This product has been designed and qualified for Multiple Level.
 Qualification Standards can be found on IR's Web site.